Photo Couplers Panasonic

CND0224A (Tentative)

Infrared Optocal Module (IrDA)

Infrared data link for cellular phones, peripheral devices

■ Features

- Compliant with IrDA Ver.1.2
- Light emitting function for remote controller
- Corresponding low I/O (interface) voltage: 1.5 V
- Corresponding reflow solder (260°C)
- Ultra-small side view package (1.6 mm \times 7.2 mm \times 2.6 mm)

■ Type

• GaAlAs LED + IC + PIN Photodiode

■ Absolute Maximum Ratings $T_a = 25$ °C±3°C

Parameter	Symbol	Rating	Unit	
Operating supply voltage	V _{CC}	-0.5 to $+3.8$	V	
Output voltage	Vo	-0.5 to $+3.8$	V	
Input voltage	V _I	-0.5 to $+3.8$	V	
Shutdown input voltage	V_{SD}	-0.5 to +3.8	V	
LED operating supply voltage	V _{LEDA}	-0.5 to +7.0	V	
Pulse forward current *	I_{FP}	300	mA	
Low level output current	I _{OL}	10	mA	
Operating ambient temperature	T _{opr}	-25 to +75	°C	
Storage temperature	T _{stg}	-30 to +85	°C	

Note) *: tw \leq 90 μ s, Duty \leq 25 %

■ Operation Condition

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating supply voltage	V _{CC}	110 _{A4} , Elyp.	2.4	2.8	3.3	V
LED operating supply voltage	V _{LEDA}	ik 10, 11, 13	2.8		4.5	V

■ Electrical-Optical Characteristics $V_{CC} = 2.8 \text{ V}, T_a = 25^{\circ}\text{C}\pm3^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
High level supply current *1	I _{CCH}	$V_{LEDA} = 3.2 \text{ V}, E_I = 0$ $V_I = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$		90	120	μΑ
Low level supply current *1	I _{CCL}	$V_{LEDA} = 3.2 \text{ V}, E_I = 3 \text{ mW/cm}^2$ $V_I = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$		150	360	μΑ
Shut down supply current *1	I _{CCSD}	$V_{LEDA} = 3.2 \text{ V}, V_{I} = 0.5 \text{ V},$ $V_{CC} \ge V_{SD} \ge V_{CC} \times 0.8 \text{ (SD = High)}$		10	200	nA
Maximum reception distance *4	L _{max}	V_{LEDA} = 3.2 V to 4.2 V, $V_{SD} \le 0.5$ V, External components	23			cm
Minimum reception distance	L _{min}	V _{LEDA} = 2.8 V to 4.2 V, LED power 150 mW/sr			0	cm

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■ Electrical-Optical Characteristics (Continued) $V_{CC} = 2.8 \text{ V}, T_a = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
RC maximum reception dista	ance	L _{maxR}	$V_{LEDA} = 3.2 \text{ V}, V_{CC} \ge V_{SD} \ge V_{CC} - 0.3 \text{ V}$ Receiver sensitivity = 0.0125 $\mu\text{W/cm}^2$	10			m
Data Rates				9.6		115.2	kbps
Transmitter							
			$V_{SD} \le 0.5 \text{ V (IrDA mode)}$ $V_{LEDA} = 3.2 \text{ V, Duty } 3/16$	878		888	nm
Peak emission wavelength *1		$\lambda_{ m P}$	$V_{SD} \le 0.5 \text{ V (IrDA mode)}$ $V_{LEDA} = 3.2 \text{ V, Duty } 3/16, T_a = -20^{\circ}\text{C to } 70^{\circ}\text{C}$	850		900	nm
			$V_{CC} = 3.0 \text{ V}, V_{SD} \le 0.5 \text{ V (RC mode)}$ $V_{LEDA} = 2.8 \text{ V}, \text{Duty 25\%}$	878		910	nm
			$V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V},$ I-TXD Duty 3/16, R-TXD $\le 0.5 \text{ V}$	40	60	90	mA
Pulse forward current *1		I_{FP}	$V_{LEDA} = 4.2 \text{ V}, V_{SD} \le 0.5 \text{ V},$ R-TXD Duty 25%, I-TXD $\le 0.5 \text{ V}$	220	250	280	mA
			$V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V},$ R-TXD Duty 25%, I-TXD $\le 0.5 \text{ V}$	170	200	230	mA
Center radiant intensity *1, 2 $\theta_{\rm T} = \pm 15$	X		$\begin{split} &V_{LEDA}=3.2 \text{ V, } V_{SD} \leq 0.5 \text{ V,} \\ &I\text{-TXD Duty } 3/16, \text{ R-TXD} \leq 0.5 \text{ V,} \\ &(\text{IrDA mode}) \end{split}$	9	20		mW/sr
	$\theta_{\mathrm{T}} = 0$	= 0	V_{LEDA} = 4.2 V, $V_{SD} \le 0.5$ V, R-TXD Duty 25%, I-TXD ≤ 0.5 V, (RC mode)	40	73	lajjor.	mW/sr
			V_{LEDA} = 3.2 V, $V_{SD} \le 0.5$ V, R-TXD Duty 25%, I-TXD ≤ 0.5 V, (RC mode)	36	68	plein!	mW/sr
		, dill'	V_{LEDA} = 3.2 V, $V_{SD} \le 0.5$ V, I-TXD Duty 3/16, R-TXD ≤ 0.5 V, (IrDA mode)	6	10		mW/sr
	$\theta_{\rm T} = \pm 15$	I _{e15}	V_{LEDA} = 4.2 V, V_{SD} \leq 0.5 V, R-TXD Duty 25%, I-TXD \leq 0.5 V, (RC mode)	28	40		mW/sr
	NELDI.		V_{LEDA} = 3.2 V, V_{SD} \leq 0.5 V, R-TXD Duty 25%, I-TXD \leq 0.5 V, (RC mode)	28	38		mW/sr
TTi-1-11:14*		**	I-TXD $V_{CC} = 2.4 \text{ V to } 3.3 \text{ V}, V_{SD} \le 0.5 \text{ V}$	V _{CC} -0.3		V _{CC}	V
High level input voltage *1		V _{IH}	R-TXD $V_{CC} = 2.4 \text{ V to } 3.3 \text{ V}, V_{SD} \le 0.5 \text{ V}$	1.5	1.8	V _{CC}	V
Low level input voltage *1		$V_{ m IL}$	$V_{CC} = 2.4 \text{ V to } 3.3 \text{ V}, V_{SD} \le 0.5 \text{ V}$	0		0.7	V
TX half-angle		θ_{T}		±15			0
Rise time *1, 3		t _r	$V_{LEDA} = 3.2 \text{ V}, t_w = 1.6 \mu\text{s}, R_L = 50 \Omega$		0.3	0.6	μs
Fall time *1,3		t_{f}	$V_{LEDA} = 3.2 \text{ V}, t_w = 1.6 \mu\text{s}, R_L = 50 \Omega$		0.3	0.6	μs
TX wake up time *7		t _{Twu}			0.3	1	μs
Intensity delay time *1,3		I_{DT}	$V_{LEDA} = 3.2 \text{ V}$			400	ns
Maximum pulse width		T _{wLEDmax}	I-TXD, R-TXD = Low \rightarrow High	20	50	100	μs
Overshoot		O_S				25	%
Edge jitter		E_{J}		-40		40	ns

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$\blacksquare \ \, \text{Electrical-Optical Characteristics (Continued)} \ \, V_{CC} = 2.8 \ V, V_{LEDA} = 3.2 \ V, T_a = 25^{\circ} \text{C} \pm 3^{\circ} \text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Receiver						
Minimum input irradiance	E _{I min}	$V_{SD} \le 0.5 \text{ V}$		2.3	6.8	μW/cm ²
Maximum input irradiance	E _{I max}	$V_{SD} \le 0.5 \text{ V}$	500			mW/cm ²
High level output voltage *5	V _{OH}	Non signal condition $I_{OH} = -200 \; \mu A, V_{SD} \leq 0.5 \; V$	V _{CC} -0.3		V _{CC}	V
Low level output voltage *6	V _{OL}	$I_{OL} = 500 \mu A, V_{SD} \le 0.5 \text{ V}$			0.5	V
RX half angle	θ_{R}		±15			0
RXD output pulse width	T_{WR}	$C_L = 15 \text{ pF}, 9.6 \text{ kbps to } 115.2 \text{ kbps}$	1.3	2.3	4.2	μs
RX wake up time *8	t _{Rwu}	$E_I = 8.1 \mu\text{W/cm}^2$		250	400	μs
Receiver latency time	$t_{ m L}$	$E_I = 8.1 \mu\text{W/cm}^2$		100	200	μs
Rise time	t _r	$C_L = 15 \text{ pF}$		100	300	ns
Fall time	$t_{\rm f}$	$C_L = 15 \text{ pF}$		100	300	ns

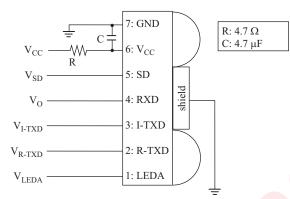


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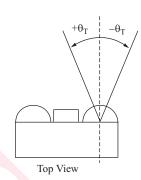
■ Electrical-Optical Characteristics (Continued)

Note) Measuring circuit

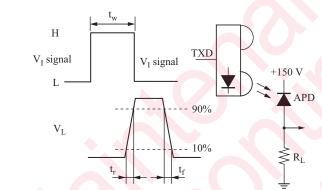
*1:



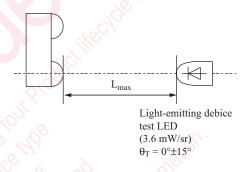
*2:



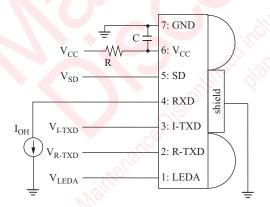
*3:



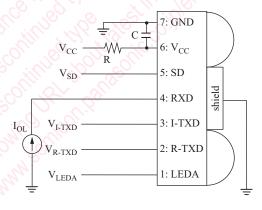
*4:



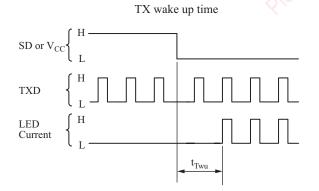
*5:



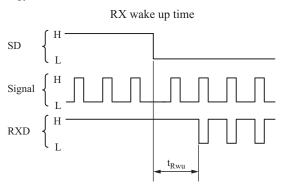
*6



*7:



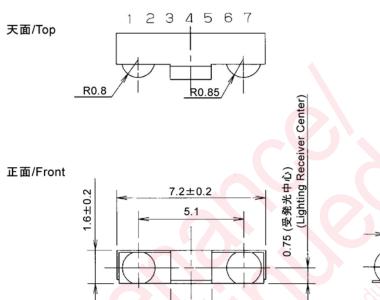
*8:



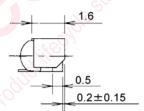
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■ Package (Unit: mm)

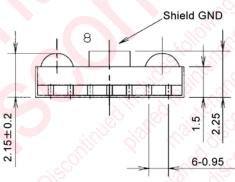
KMTLSM7K0001



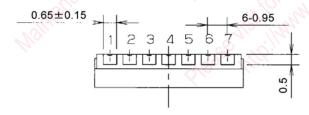
2.0







背面/Back



- Pin name
 - $\begin{array}{ll} \text{1. LEDA} & \text{5. SD} \\ \text{2. R-TXD} & \text{6. V}_{\text{CC}} \end{array}$
 - 3. I-TXD 7. GND
 - 4. RXD 8. Shield GND

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